IN	THE	UNITED	<b>STATES</b>	<b>PATENT</b>	<b>AND</b>	TRADEMARK	<b>OFFICE</b>

APPLICANT: Sadeg M. Faris

) Group Art Unit

SERIAL NO.: Tbd

Tbd

FILING DATE: November 20, 2003

Examiner

Tbd

FOR:

Method Of Fabricating Multi Layer

Devices On Buried Oxide Layer Substrates

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

TRANSMITTAL of NEW PATENT APPLICATION UNDER 37 CFR 1.53

Sir:

Applicant is a small entity.

Please find enclosed herewith:

- 1) New Patent Application, including:
  - a. Specification (84 pages)
  - b. Claims (4 pages)
  - c. Abstract (1 page)
  - d. Figures (50 sheets)
- 2) Declaration and Power of Attorney (unexecuted)
- 3) Postcard

Respectfully submitted,

Registration No. 41,896

Date: November 20, 2003 REVEO, INC.

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I hereby certify that this correspondence is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to:

Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

November 20, 2003

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Page 1 of 1